

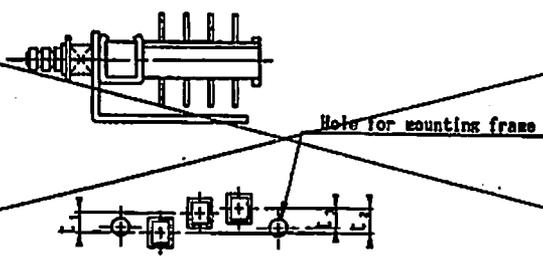
SPPH-S-501	SPPH1 PRODUCT SPECIFICATIONS	
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- 1. General**
 1.1 Application This specification is applied to low current circuit (Secondary circuit) push switch used for electronic equipment.
 1.2 Operating temperature range : -10 ~ 60°C
 1.3 Test conditions The standard test conditions shall be 5~35°C in temperature, 45~85% RH and 86~106kPa ~~1860~1060 hPa~~ Δ in atmospheric pressure. Should any doubt arise in judgment, tests shall be conducted at 20±2°C, 65±5% RH and 86~106kPa ~~1860~1060 hPa~~ Δ
- 2. Appearance, construction and dimensions**
 2.1 Appearance Switch shall have good finishing, and shall have no rust, crack or plating failures.
 2.2 Construction and dimensions Per individual product drawing
 2.3 Markings Per individual product drawing
- 3. Rating** 30 V DC 0.1 A (Resistive load)
- 4. Electrical performance**

Items	Test conditions	Criterion
4.1 Contact resistance	Shall be measured at 1kHz±200Hz (20mV MAX , 50mA MAX) or 1A, 5V DC by voltage drop method.	20 mΩ MAX
4.2 Insulation resistance	Test voltage : 500 V DC, measured after 1 minute±5 seconds. Applied position : Between all terminals Between terminals and ground (frame)	100 MΩ MIN
4.3 Voltage proof	Test voltage : 500 V AC (50~60Hz, cut-off current 2 mA) Applied position : Between all terminals Between terminals and ground (frame) Duration: 1 minute	No dielectric breakdown shall occur.
4.4 Capacitance	Shall be measured at 1kHz ± 10kHz Between all terminals Between terminals and ground (frame) Between all circuits	1.5 pF MAX
4.5 Changeover timing		As per individual product drawing.

5. Mechanical performance

Items	Test conditions	Criterion
5.1 Operating force	A static load shall be applied to the tip of actuator in operating direction.	As per individual product drawing.
5.2 Terminal strength	A static load of 5 N ± 5.10 mN Δ shall be applied to the tip of terminal in a desired direction for 1 minute. The number of test shall be once per terminal.	Shall be free from terminal looseness and damage and breakage of terminal holding portion. Terminals may be bent after test, electrical performance requirement specified in item 4 shall be satisfied.
5.3 Mounting strength of thread portion	Thread shall be mounted at N·m (kgf·cm) by normal mounting method.	Shall be free from damage of thread portion.
5.4 Control strength	(1) A static load of 50N ± 5.1 mN Δ shall be applied in the operating direction of actuator for 15 seconds. (2) A static load of 30N ± 3.06 mN Δ shall be applied in the pull direction of actuator for 15 seconds. (For construction with lock, the test shall be conducted at the condition of lock released.) (3) A static load of 10N ± 1.02 mN Δ shall be applied to the vertical direction of operation at the tip of actuator for 15 seconds.	Shall be free from pronounced vobble, bending and mechanical abnormalities.
5.4.1 Control strength		
5.4.2 Lock holding strength of actuator (Applied to the switch with lock mechanism)	(1) A static load of 5N ± 0.51 mN Δ shall be applied in the pull direction at the condition of locking actuator.	Lock shall not be dislocated. Shall be free from pronounced vobble and abnormalities in operation.
5.5 Vobble of actuator	Run-out(P-P) shall be measured by applying a static load of 1N ± 102 mN Δ in the vertical direction of operation at the tip of actuator.	P-P : 1 mm MAX
5.6 Key of actuator (Applied to multipul-key push switch)	Switch shall be mounted as shown. Difference of sides shall be measured.	Difference between actuators t ₁ = Within ____ mm Maximum difference of actuator t ₂ = Within ____ mm Difference between mounting hole and actuator t ₃ = Within ____ mm



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Items	Test conditions	Criterion
5.7 Mounting frame strength (Applied to multi-pul-key push switch)	Both ends of mounting frame shall be secured. A static load of N (kgf) shall be applied to the center of mounting frame in A, B, C and D directions each 15 seconds. <div style="text-align: center;"> </div>	Warp on mounting frame shall be 0.5mm max. Shall be free from abnormalities in operation.
5.8 Vibration	Switch shall be secured to a testing machine by a regular mounting device and method. (1) Vibration frequency range : 10~55Hz (2) Total amplitude : 1.5mm (3) Sweep ratio : 10-55-10(Hz) Approx. 1 minute (4) Method of changing the sweep vibration frequency : Logarithmic or linear (5) Direction of vibration : Three vertical directions including actuator. (6) Time : 2 hours each (6 hours in total)	Contact resistance (Item 4.1) : <u>20</u> Ω MAX Insulation resistance (Item 4.2) : <u>100</u> Ω MIN Voltage proof (Item 4.3) : Apply <u>500</u> V AC for 1 minute. No dielectric breakdown shall occur. Operating force (Item 5.1) : Within <u>± 18</u> % of specified value. No abnormalities shall be recognized in appearance and construction.
5.9 Mechanical shock 5.9.1 Mechanical shock	Switch shall be measured after following test. (1) Mounting method : Normal mounting method (2) Acceleration : 490m/s^2 ($\leftarrow 50g \rightarrow$) (3) Duration : 11ms (4) Test direction : 6 directions (5) Number of shock : 3 times per direction (18 times in total)	Contact resistance (Item 4.1) : <u>20</u> Ω MAX Operating force (Item 5.1) : Within <u>± 18</u> % of specified value. Shall be free from mechanical abnormalities. (Dislocation of lock of actuator shall not be regarded as abnormalities.)
5.9.2 Lock holding shock (Applied to the switch with lock mechanism.)	Switch shall be conducted at the condition of locking actuator. (1) Acceleration : 147m/s^2 ($\leftarrow 15g \rightarrow$) (2) Duration : 11ms (3) Test direction : 6 directions (4) Number of shock : 3 times per direction (18 times in total)	Lock of actuator shall not be dislocated. Shall be free from abnormalities in operation.
5.10 Solderability	Switch shall be checked after following test. (1) Solder : H63A (JIS Z 3282) (2) Flux : Rosin flux (JIS K 5902) having a nominal composition of 25% solids by weight of water white rosin in methyl alcohol (JIS K 1501) solution. (3) Soldering temperature : $230 \pm 5^\circ\text{C}$ Immersing time : 3 ± 0.5 s Flux immersing time shall be 5~10 seconds in normal temperature. (4) Immersion depth : Immersion depth shall be at copper plating portion for P.C.B. terminal after mounting. Thickness of P.C. board : 1.6 mm Immersion depth shall be at wiring portion of lead wire for lead wire terminal.	More than 90% of immersed part shall be covered with solder.
5.11 Soldering heat resistance	Switch shall be measured after following test. (1) Solder : H63A (JIS Z 3282) (2) Flux : Rosin flux (JIS K 5902) having a nominal composition of 10% solids by weight of water white rosin in methyl alcohol (JIS K 1501) solution. (3) Temperature and immersing time	No abnormalities shall be recognized in appearance. The electrical performance requirements specified in item 4 shall be satisfied.

	Temperature ($^\circ\text{C}$)	Time (s)
Automatic soldering	250 ± 5	10 ± 1
Manual soldering	350 ± 10	3 ± 1

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